

Device Modeling Report

COMPONENTS: MOSFET (Model Parameters)
PART NUMBER: 2SK3704
MANUFACTURER: SANYO
REMARK: Body Diode (Model Parameters) /
ESD Protection Diode



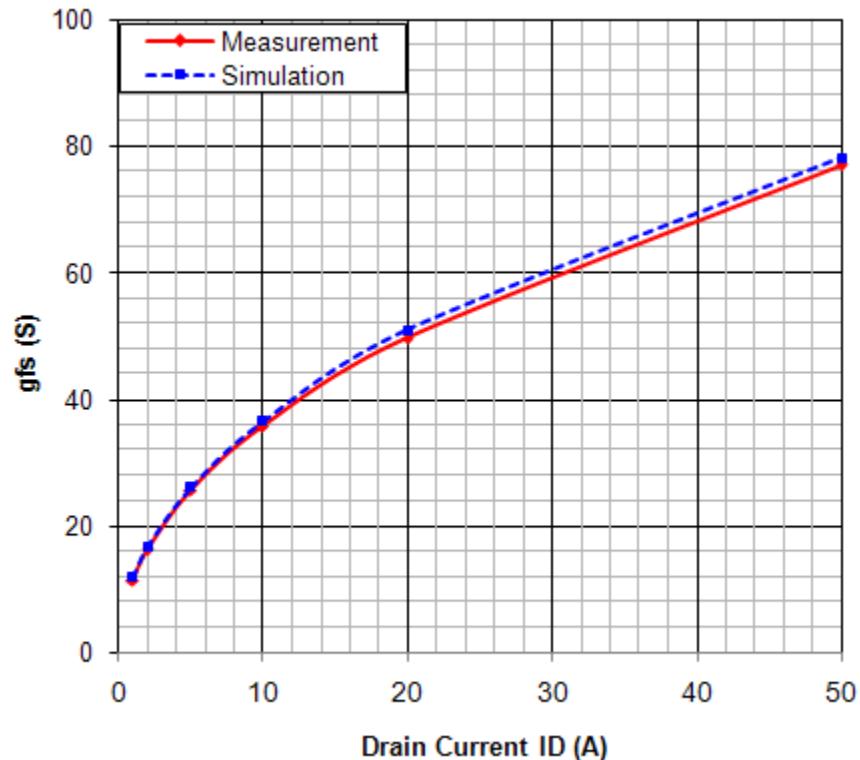
Bee Technologies Inc.

MOSFET MODEL

PSpice model parameter	Model description
LEVEL	
L	Channel Length
W	Channel Width
KP	Transconductance
RS	Source Ohmic Resistance
RD	Ohmic Drain Resistance
VTO	Zero-bias Threshold Voltage
RDS	Drain-Source Shunt Resistance
TOX	Gate Oxide Thickness
CGSO	Zero-bias Gate-Source Capacitance
CGDO	Zero-bias Gate-Drain Capacitance
CBD	Zero-bias Bulk-Drain Junction Capacitance
MJ	Bulk Junction Grading Coefficient
PB	Bulk Junction Potential
FC	Bulk Junction Forward-bias Capacitance Coefficient
RG	Gate Ohmic Resistance
IS	Bulk Junction Saturation Current
N	Bulk Junction Emission Coefficient
RB	Bulk Series Resistance
PHI	Surface Inversion Potential
GAMMA	Body-effect Parameter
DELTA	Width effect on Threshold Voltage
ETA	Static Feedback on Threshold Voltage
THETA	Mobility Modulation
KAPPA	Saturation Field Factor
VMAX	Maximum Drift Velocity of Carriers
XJ	Metallurgical Junction Depth
UO	Surface Mobility

Transconductance Characteristic

Circuit Simulation Result

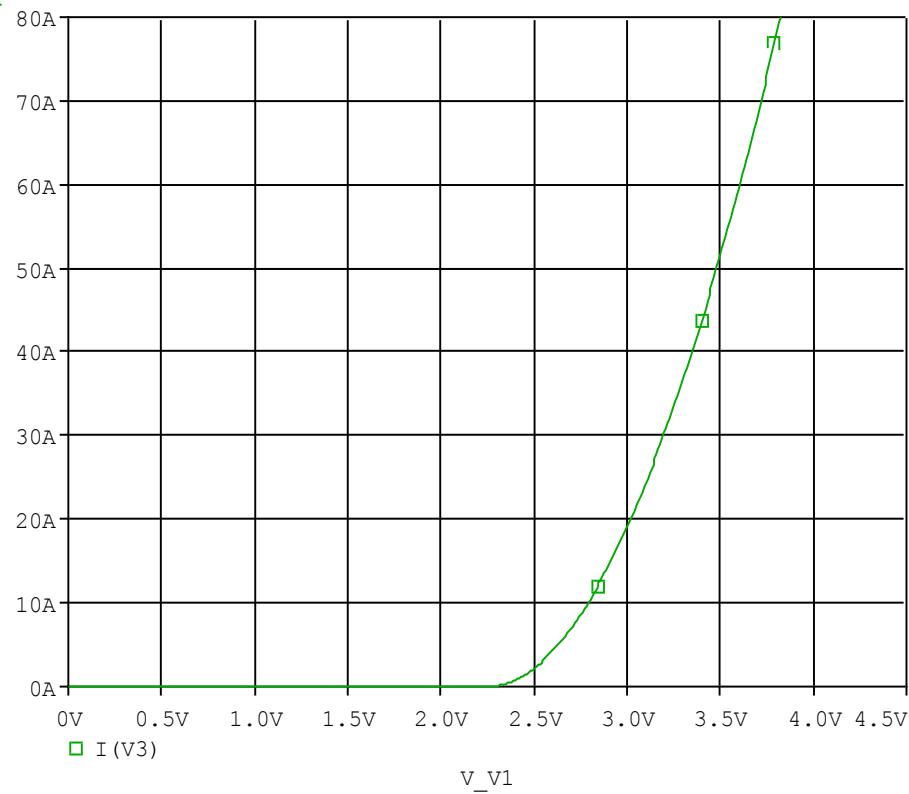


Comparison table

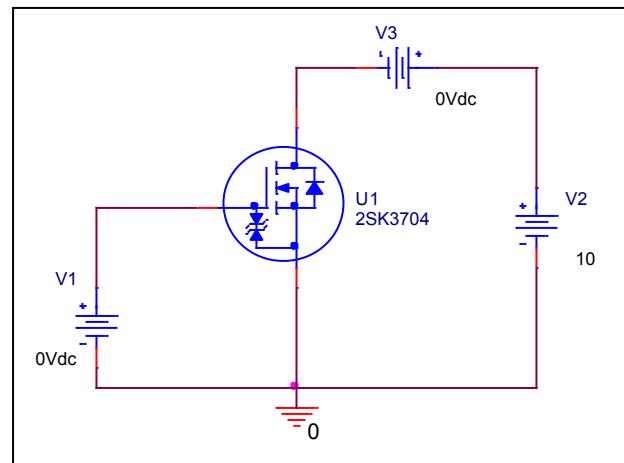
Id(A)	gfs (s)		Error (%)
	Measurement	Simulation	
1	11.400	11.831	3.78
2	16.250	16.659	2.52
5	25.550	26.096	2.14
10	35.750	36.513	2.13
20	49.750	50.871	2.25
50	77.000	78.126	1.46

V_{gs}-I_d Characteristic

Circuit Simulation result

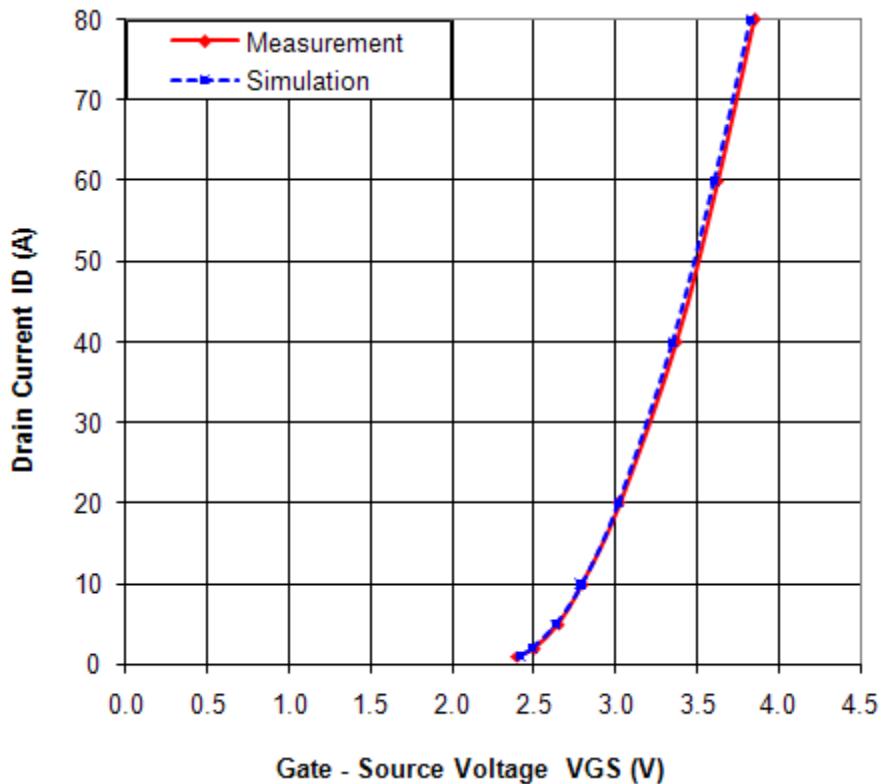


Evaluation circuit



Comparison Graph

Circuit Simulation Result

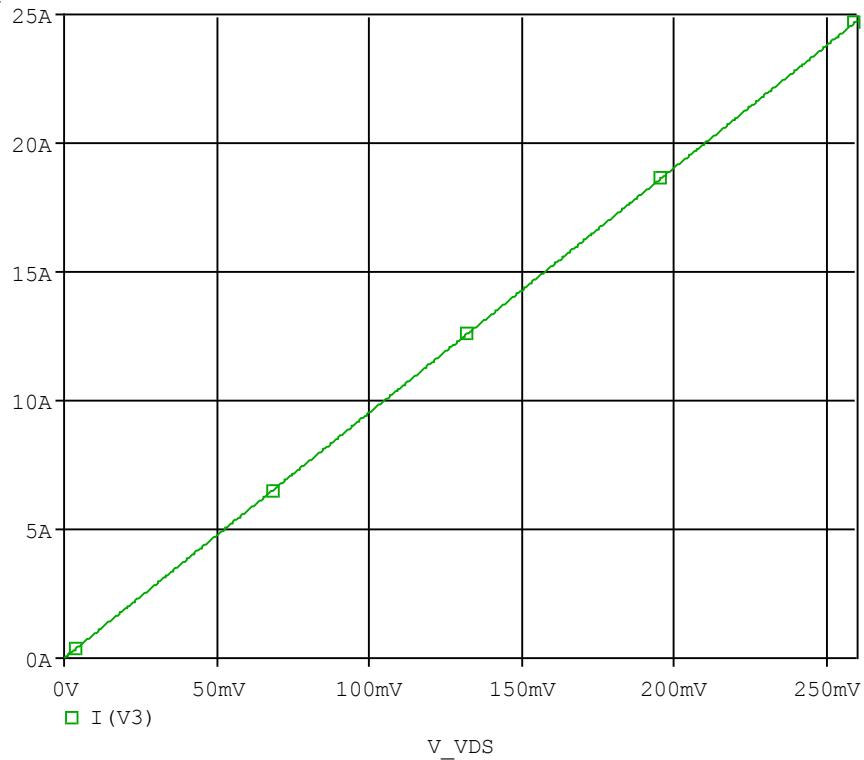


Simulation Result

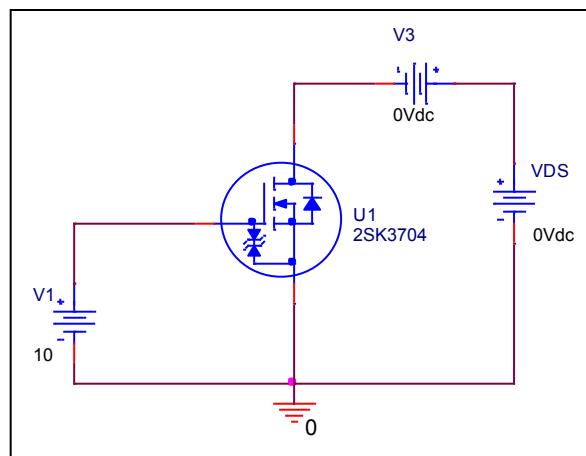
I_D (A)	V_{GS} (V)		Error (%)
	Measurement	Simulation	
1	2.400	2.420	0.846
2	2.505	2.490	-0.599
5	2.650	2.631	-0.717
10	2.800	2.790	-0.357
20	3.025	3.018	-0.231
40	3.375	3.347	-0.830
60	3.625	3.605	-0.552
80	3.850	3.825	-0.649

R_{DS(on)} Characteristic

Circuit Simulation result



Evaluation circuit

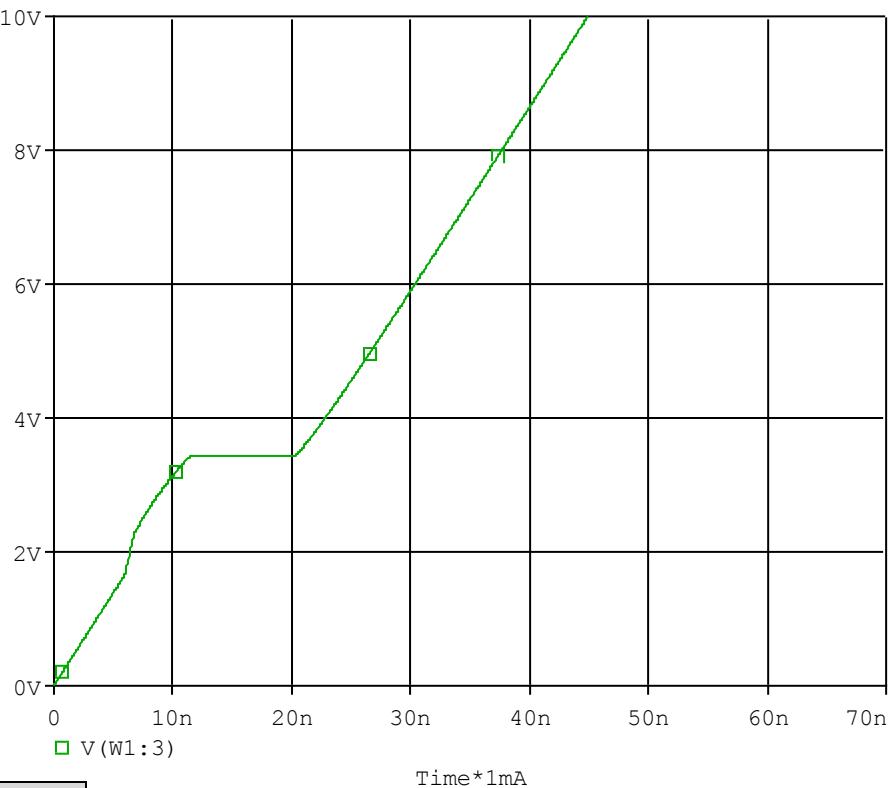


Simulation Result

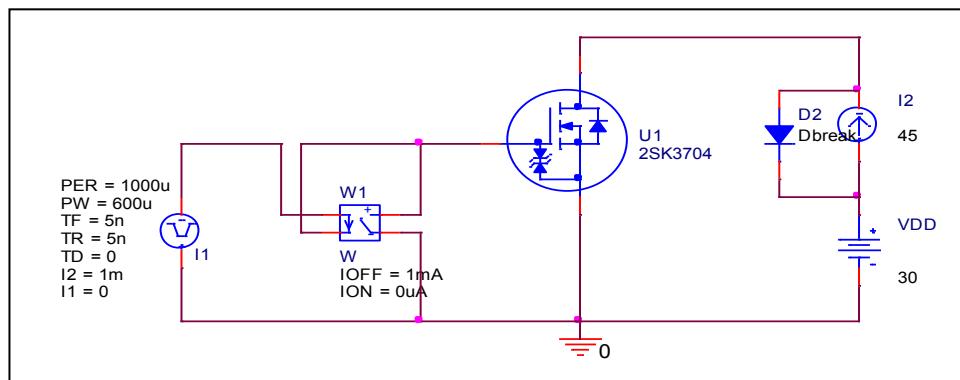
$I_D = 23A, V_{GS} = 10V$	Measurement	Simulation	Error (%)
$R_{DS(on)}$ mΩ	10.500	10.500	0.00

Gate Charge Characteristic

Circuit Simulation result



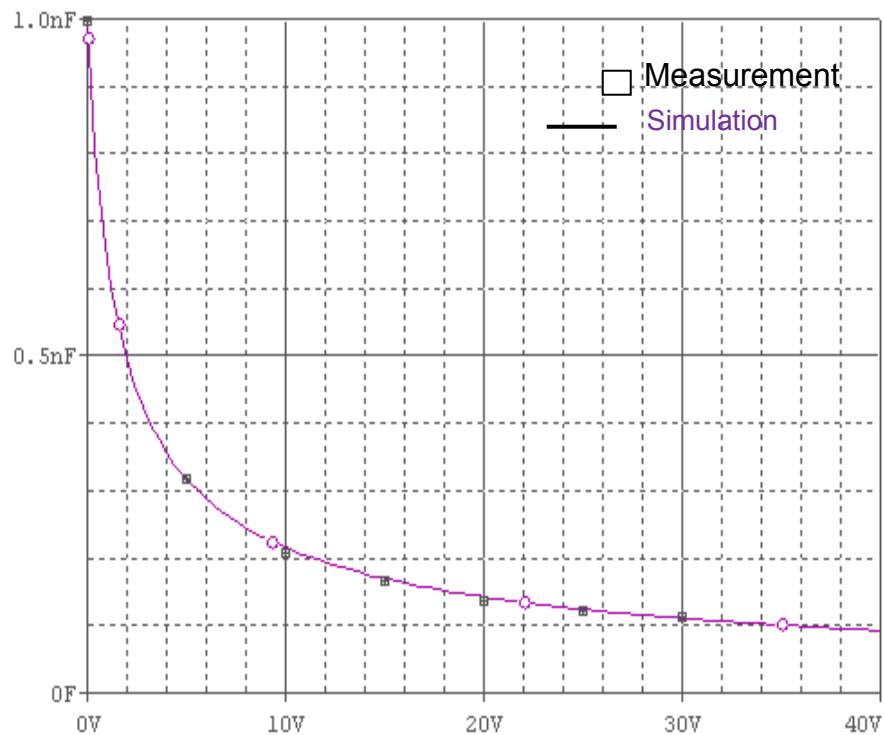
Evaluation circuit



Simulation Result

$V_{DD}=30V, I_D=45A, V_{GS}=10V$		Measurement	Simulation	Error (%)
Qgs	nC	10.600	10.601	0.01
Qgd	nC	10.000	10.096	0.96
Qg	nC	67.000	44.908	-32.97

Capacitance Characteristic

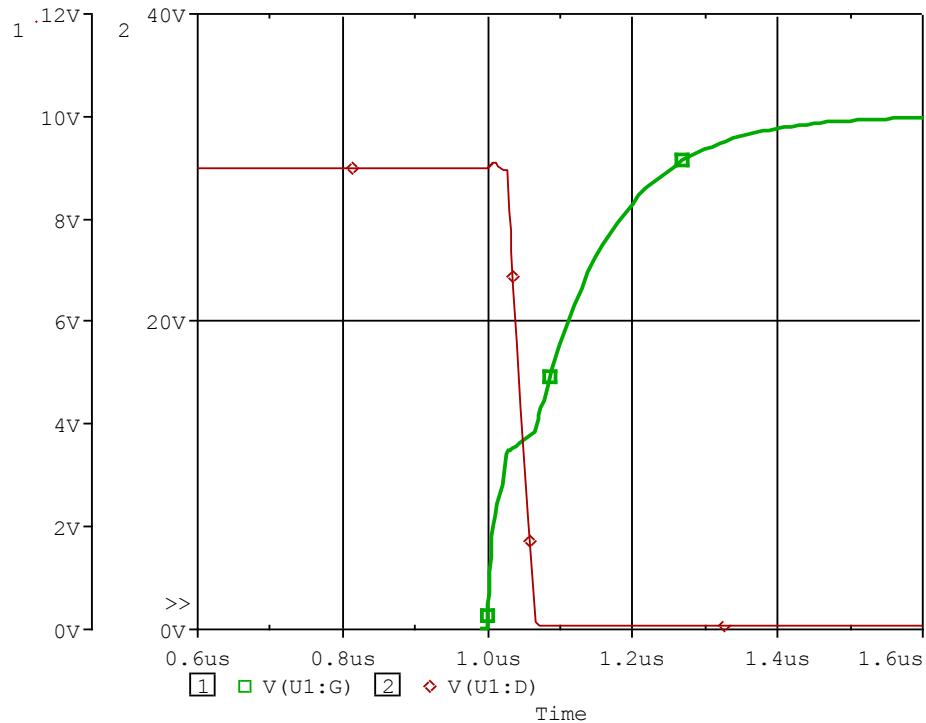


Simulation Result

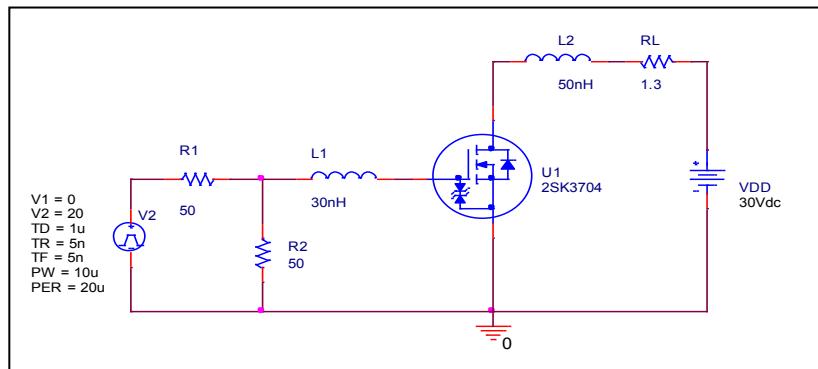
V_{DS} (V)	C _{DS} (pF)		Error (%)
	Measurement	Simulation	
0.0	1000.00	999.000	-0.10
5.0	320.00	317.500	-0.78
10.0	212.00	215.000	1.42
15.0	170.00	169.000	-0.59
20.0	140.00	142.000	1.43
25.0	125.00	124.000	-0.80
30.0	115.00	112.000	-2.61

Switching Time Characteristic

Circuit Simulation result



Evaluation circuit

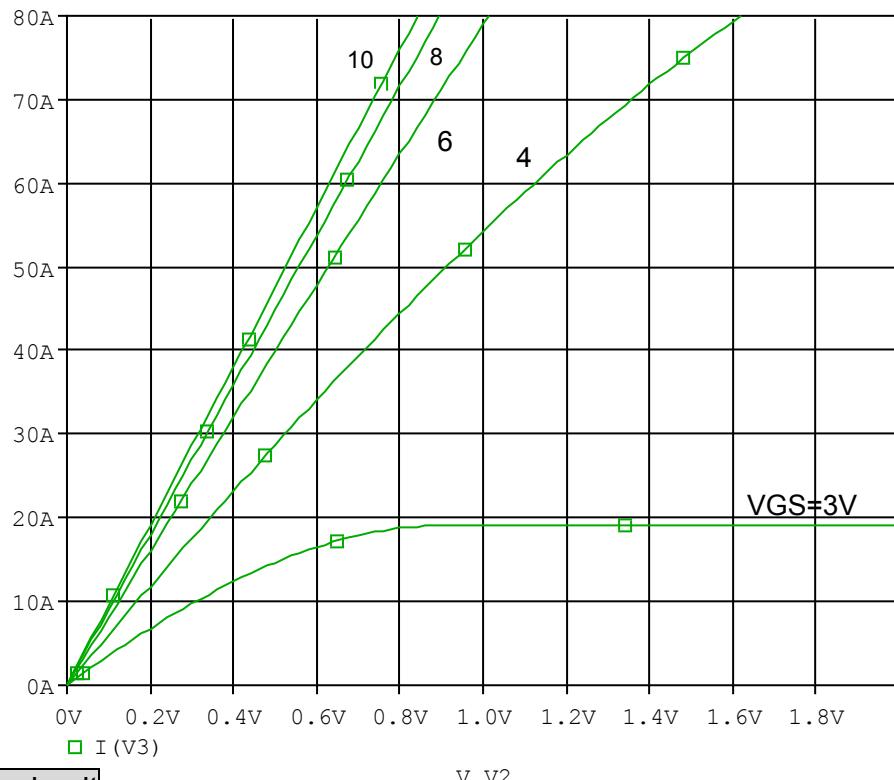


Simulation Result

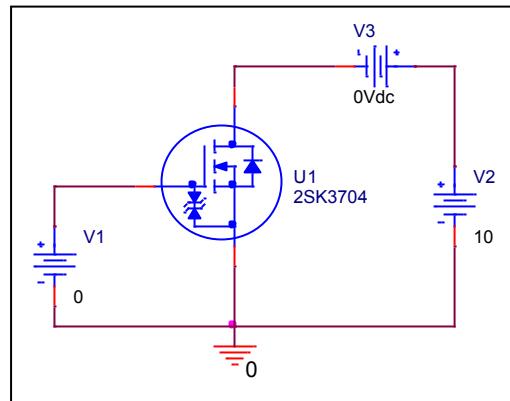
I_D=23A, V_{DD}=30V V_{GS}=0/10V		Measurement	Simulation	Error (%)
td(on)	ns	26.000	26.103	0.40

Output Characteristic

Circuit Simulation result

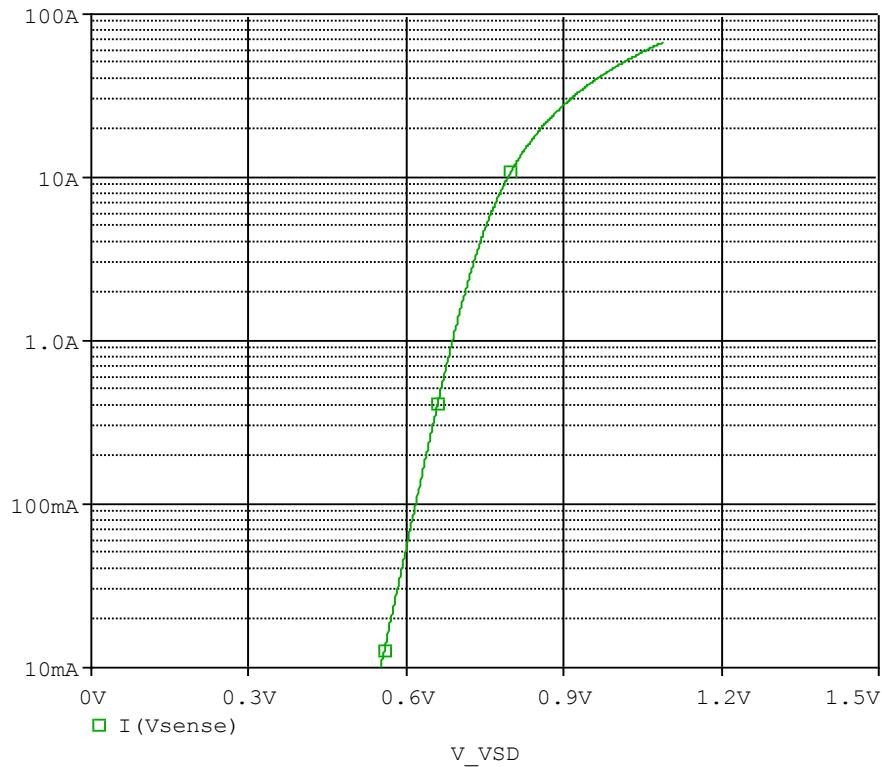


Evaluation circuit

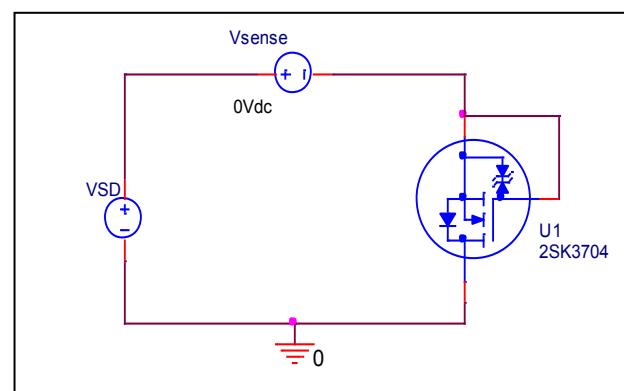


Forward Current Characteristic

Circuit Simulation Result

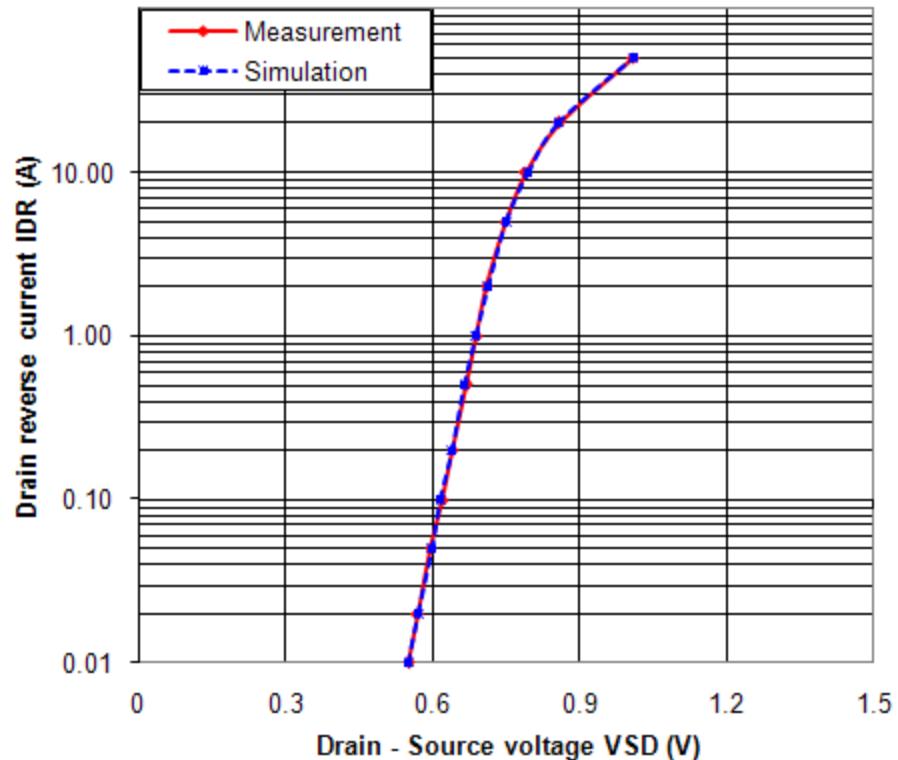


Evaluation Circuit



Comparison Graph

Circuit Simulation Result

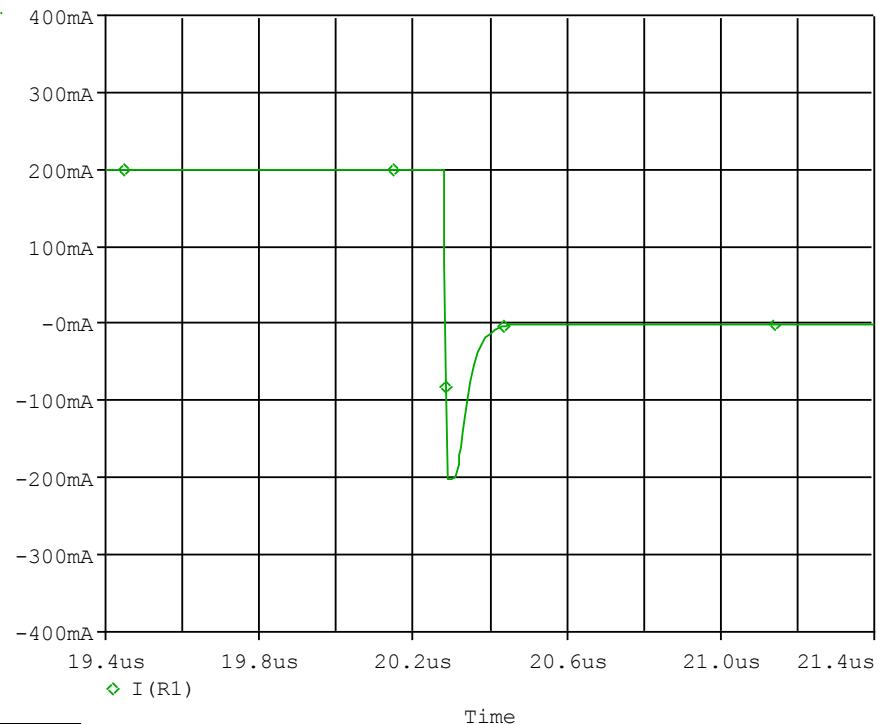


Simulation Result

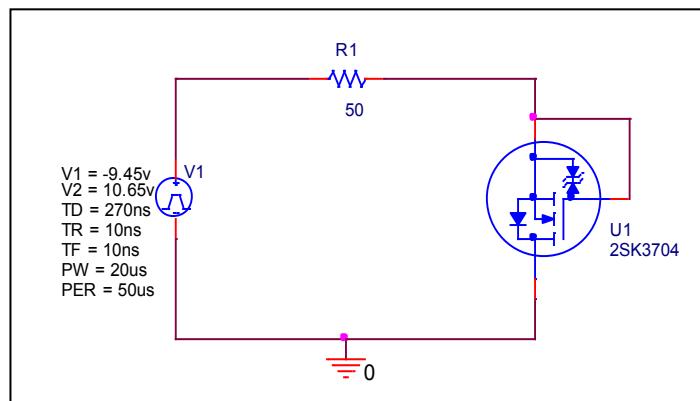
IDR(A)	VSD(V)		%Error
	Measurement	Simulation	
0.01	0.550	0.551	0.18
0.02	0.570	0.571	0.18
0.05	0.595	0.597	0.34
0.10	0.620	0.617	-0.48
0.20	0.640	0.638	-0.31
0.50	0.670	0.665	-0.75
1.00	0.690	0.687	-0.43
2.00	0.710	0.712	0.28
5.00	0.748	0.751	0.40
10.00	0.790	0.793	0.38
20.00	0.860	0.857	-0.35
50.00	1.010	1.010	0.03

Reverse Recovery Characteristics

Circuit Simulation Result



Evaluation Circuit

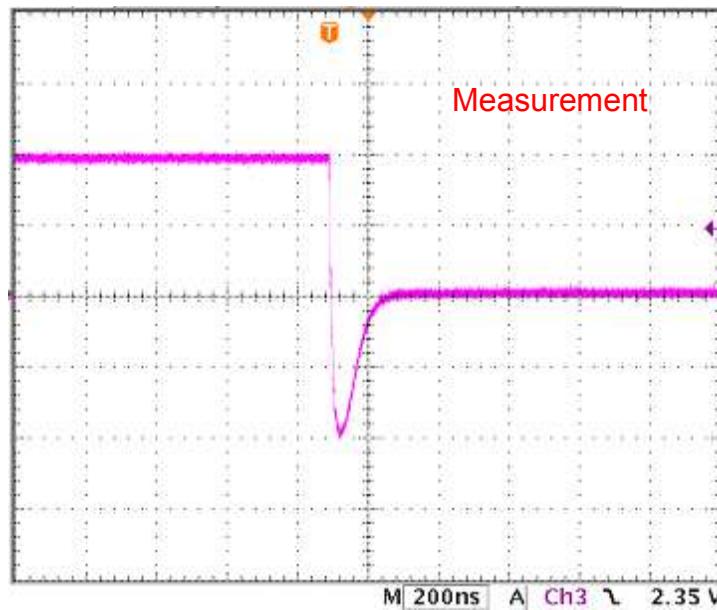


Compare Measurement vs. Simulation

		Measurement	Simulation	Error (%)
trj	ns	24.000	24.081	0.34

Reverse Recovery Characteristic

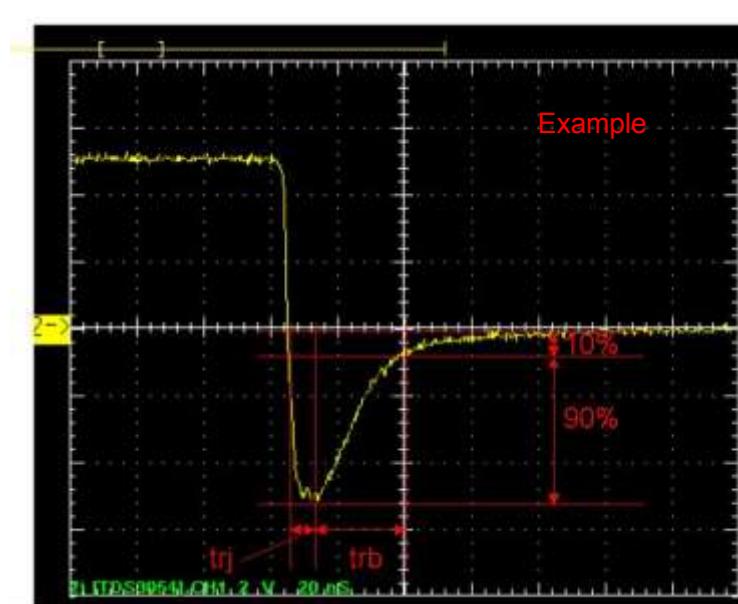
Reference



Trj= 24 (ns)

Trb= 76 (ns)

Conditions: Ifwd=Irev=0.2(A), RI=50

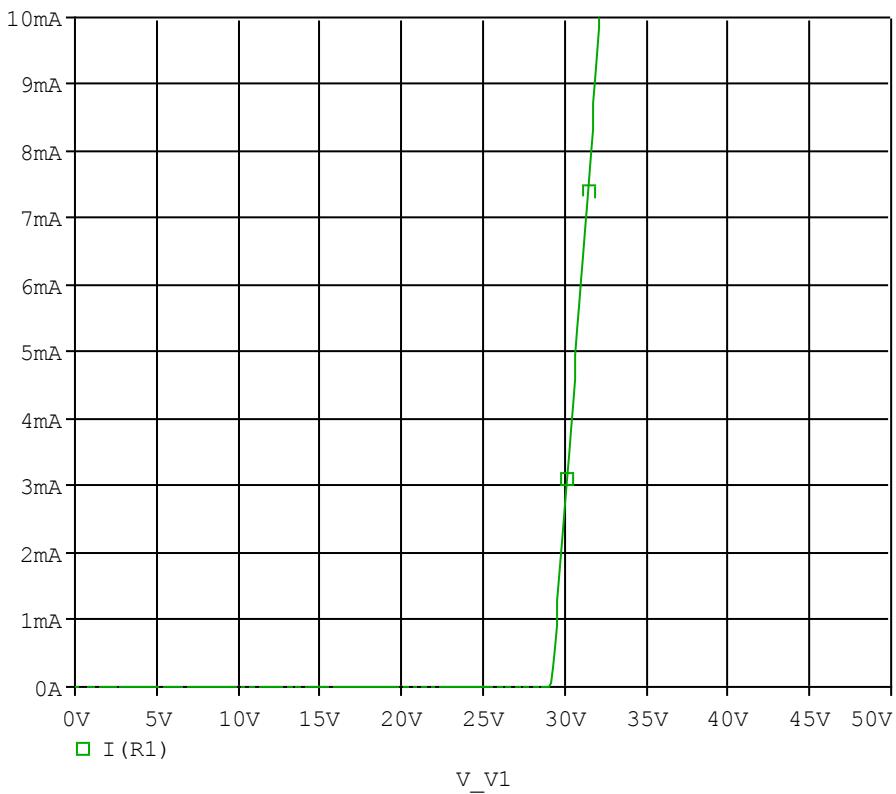


Relation between trj and trb

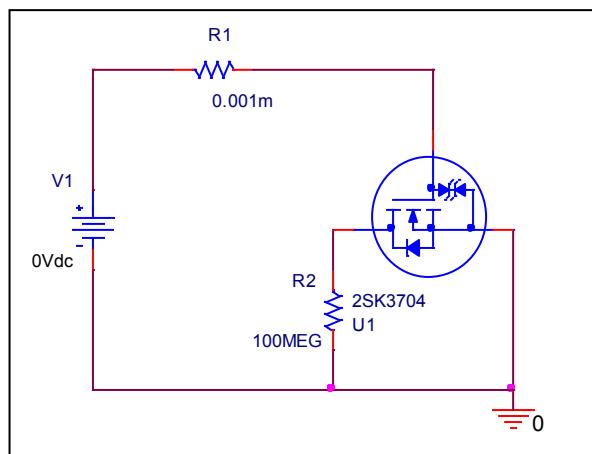
ESD PROTECTION DIODE SPICE MODEL

Zener Voltage Characteristic

Circuit Simulation Result



Evaluation Circuit



Zener Voltage Characteristic

Reference

